



VULQ1-S / FLASH series MULTIBEAM LASER MARKING SYSTEMS



VULQ1™ product offer overview

BETTER LASER SOLUTIONS FOR A BETTER MANUFACTURING

Laser is the production tool of the future. But the way laser solutions are designed today limits their performance. Conventional laser processing reaches 3 limits:

- Throughput limit: with high power laser available, throughput is limited by the speed of the laser beam onto the sample. This is particularly true for high resolution applications.
- Economical limit: adding to the processing time induced by throughput limit, it is frequent to use only part of the available laser power.
- Environmental limit: laser processing is intrinsically a green production tool, it will be even greener running at 100% of its capacity.

Multibeam laser processing with VULQ1 unlocks these three bottlenecks.

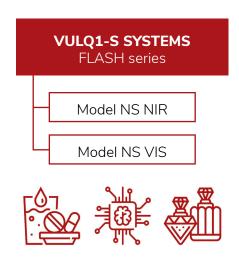
Multibeam processing is the combination of dynamic laser beam shaping with **VULQ1** and traditional laser beam delivery systems.

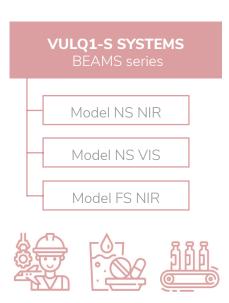
Powered by our patented programmable multibeam technology, VULQ1 accelerates laser processing manyfold compared to conventional laser marking.

















VULQ1-S/FLASH series deliver markings in a single laser pulse, millions of times faster than any other marking solutions.

VULQ1-S / FLASH is a stand-alone multibeam laser marking system, ready for integration into all production environments, production line or stand-alone machine.

Featured operation mode is FULL-STAMP marking breakthrough innovation, internationally patented, which delivers markings in one single laser pulse (2D code, logo, alphanumerics).

VULQ1-S / FLASH series are available in 1064 nm and 532 nm single wavelength, up to 40 mJ energy at 100 Hz to deliver tens of unique Datamatrix codes per second.

MAIN APPLICATIONS

- In-line product and components serialization
- High-speed micro-codes marking
- Anticounterfeiting

FEATURES

- Shortest marking time of the market
- Code size down to 500 μm
- Dynamically configurable beam shape and Z focus

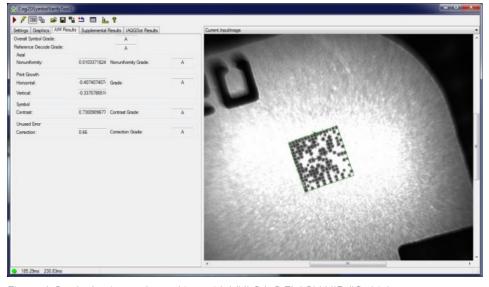




Figure 1:Grade A microcode marking with VULQ1-S FLASH NIR (IC chip)

Product line	Model	Max energy	Max power	Pulse duration	Wavelength	Materials	Marking time
VULQ1-S FLASH series	NIR	40 mJ	4 W	ns	1064 nm	Metals, coated materials, polymers, molded compound	< 10 ns
	VIS	40 mJ	4 W	ns	532 nm	Polymers, films, multilayers, elastomers	< 10 ns

Figure 2: FLASH series overview





Specifications

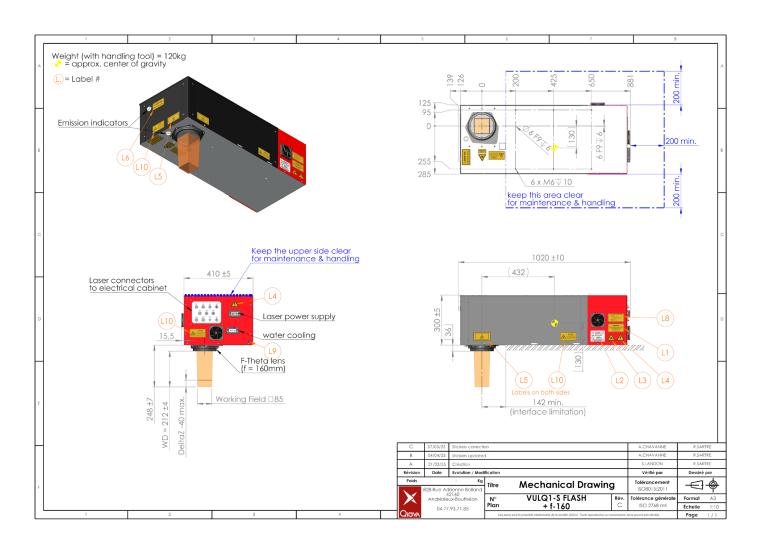
M	ODEL	FLASH NIR	FLASH VIS		
Laser processing					
Laser output					
Wavelength		1000-1100 nm	500-550 nm		
Max power		4 W	4 W		
Pulse duration		< 10 ns	< 10 ns		
Max pulse energy ¹		40 mJ	40 mJ		
Max Pulse Repetition Rate		100 Hz			
Optical output		100	112		
F-theta focal length		F80, F160	F80, F160		
Working distance range		80 - 220 mm	80 - 220 mm		
Max 3D scanning volume		100 mm x 100 mm x 40 mm	100 mm x 100 mm x 40 mm		
Modes of operation		100 mm x 100 mm x 40 mm	100 mm x 100 mm x 40 mm		
Single beam processing		NO	NO		
Multibeam processing		NO	NO		
FULL-STAMP marking		NO VEC	NO VEC		
PIXEL-STAMP marking		YES	YES		
Dimensions and weight		NO	NO		
Laser head					
Laser head max dimensions	Length	1030 mm			
	Width	431 mm			
Height		461 mm			
Laser head max weight		120 kg max. without handling tool			
Electrical cabinet					
Max dimensions		0,6 m x 0,6 m x 2 m			
Max weight		200 kg max.			
Cable length to laser head		5 m standard			
Safety and norm					
Laser safety class ²		4			
Safety level performance ³		d			
Safety contacts type		Dry contacts			
CE compliance		YES			
Utility & ambiant					
Electrical input	Voltage	230 VAC			
	Frequency	50-60 Hz			
	Supply	3 different lines 1	4 A / 8.2 A / 6 A		
	Max Power	6,5 kVA			
PLC communication		Ethernet, EthernetIP, ProfiNet			
Electrical outputs	Opto outputs (open collector)	Supply voltage: 5 V (not provided)			
		Commuting level : 5 V			
		Sink current : 35 mA			
	DAC	Max 15 mA			
		Software adjustable Max v			
		Max frequen			
Environment		iviax irequen			
Temperature	Min storage range	10.40% pag andaraing			
	i iii storage range	10-40°C, non condensing 20-30°C, non condensing			
- Cimporatare	Min operation range				

 $^{^1}$ Depends on pulse duration and wavelength – contact us for more details capabilities 2 According to IEC 6025-1:2014 3 According to ISO 13849-1:2023





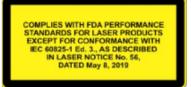
Laser head drawing with F160 lens











QiOVA follows a policy of continuous product improvement. Specifications are subject to change without notice.



